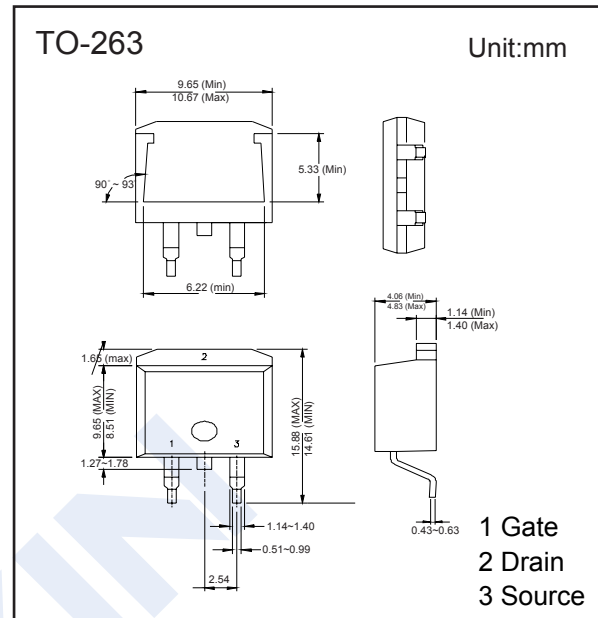
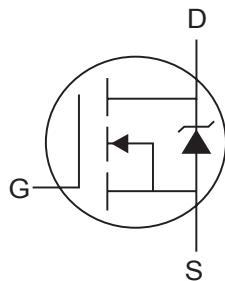


## N-Channel MOSFET

### IRF540NS (KRF540NS)

#### ■ Features

- $V_{DS} (V) = 100V$
- $I_D = 33 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 44m\Omega (V_{GS} = 10V)$
- Fast Switching



#### ■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	$V_{DS}$	100	V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$		
Continuous Drain Current	$I_D$	$T_a=25^\circ C$	33	A
		$T_a=70^\circ C$	23	
Pulsed Drain Current	$I_{DM}$	110		
Avalanche Current	$I_{AR}$	16	A	
Repetitive Avalanche Energy	$E_{AR}$	13	mJ	
Peak Diode Recovery $dv/dt$	$dv/dt$	7	V/ns	
Power Dissipation	$P_D$	130	W	
Linear Derating Factor		0.87	W/ $^\circ C$	
Thermal Resistance.Junction- to-Ambient	$R_{thJA}$	40	$^\circ C/W$	
Thermal Resistance.Junction- to-Case	$R_{thJC}$	1.15		
Junction Temperature	$T_J$	175	$^\circ C$	
Storage Temperature Range	$T_{stg}$	-55 to 175		

## N-Channel MOSFET

### IRF540NS (KRF540NS)

■ Electrical Characteristics  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{DS}$	$I_D=250\ \mu\text{A}$ , $V_{GS}=0\text{V}$	100			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=100\text{V}$ , $V_{GS}=0\text{V}$			25	$\mu\text{A}$
		$V_{DS}=80\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=150^\circ\text{C}$			250	
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS}=0\text{V}$ , $V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_D=250\ \mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}$ , $I_D=16\text{A}$ (Note.1)			44	$\text{m}\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=50\text{V}$ , $I_D=16\text{A}$ (Note.1)	21			S
Input Capacitance	$C_{iss}$	$V_{GS}=0\text{V}$ , $V_{DS}=25\text{V}$ , $f=1\text{MHz}$		1960		pF
Output Capacitance	$C_{oss}$			250		
Reverse Transfer Capacitance	$C_{rss}$			40		
Total Gate Charge	$Q_g$	$V_{GS}=10\text{V}$ , $V_{DS}=80\text{V}$ , $I_D=16\text{A}$ (Note.1)			71	nC
Gate Source Charge	$Q_{gs}$				14	
Gate Drain Charge	$Q_{gd}$				21	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10\text{V}$ , $V_{DS}=50\text{V}$ , $I_D=16\text{A}$ , $R_G=5.1\ \Omega$ (Note.1)		11		ns
Turn-On Rise Time	$t_r$			35		
Turn-Off Delay Time	$t_{d(off)}$			39		
Turn-Off Fall Time	$t_f$			35		
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F=16\text{A}$ , $di/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$		115	170	nC
Body Diode Reverse Recovery Charge	$Q_{rr}$			505	760	
Internal Drain Inductance	$L_D$	Between lead, 6mm (0.25in.) from package and center of die contact		4.5		nH
Internal Source Inductance	$L_S$			7.5		
Single Pulse Avalanche Energy	$E_{AS}$	$I_{AS}=16\text{A}$ , $L=1.5\text{mH}$			185	mJ
Maximum Body-Diode Continuous Current	$I_S$	MOSFET symbol showing the integral reverse p-n junction diode.			33	A
Pulsed Source Current	$I_{SM}$				110	
Diode Forward Voltage	$V_{SD}$	$I_S=16\text{A}$ , $V_{GS}=0\text{V}$ , $T_J=25^\circ\text{C}$			1.2	V

Note.1: Pulse width  $\leq 400\ \mu\text{s}$ ; duty cycle  $\leq 2\%$ .

## N-Channel MOSFET IRF540NS (KRF540NS)

■ Typical Characteristics

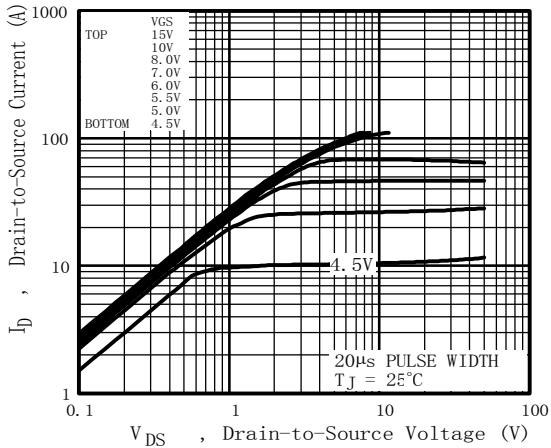


Fig 1. Typical Output Characteristics

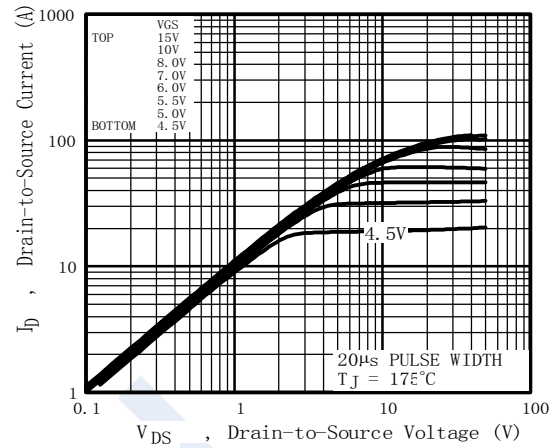


Fig 2. Typical Output Characteristics

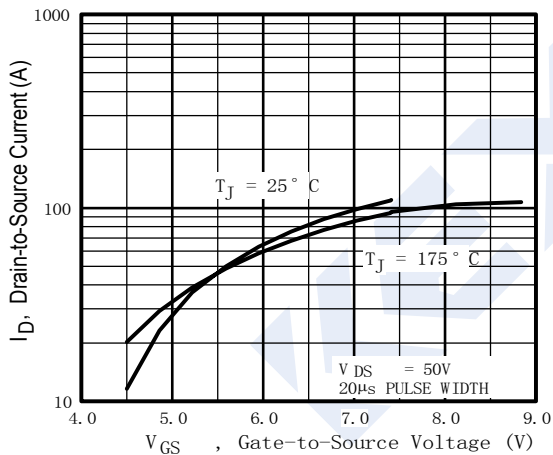


Fig 3. Typical Transfer Characteristics

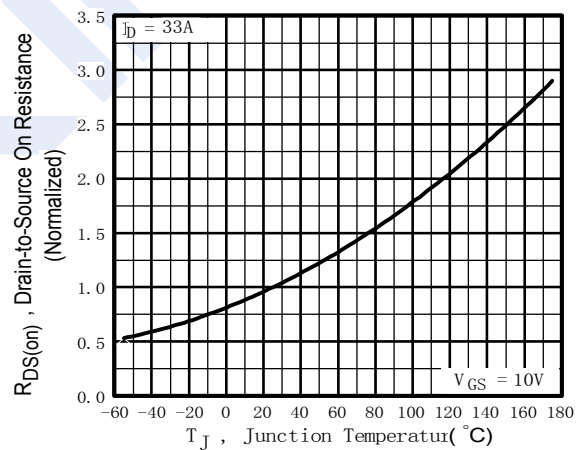


Fig 4. Normalized On-Resistance Vs. Temperature

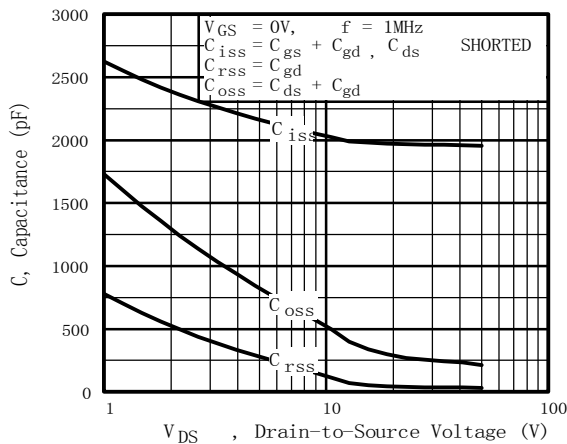


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

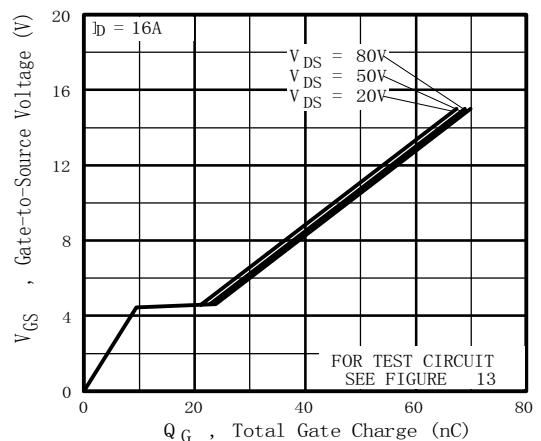


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

## N-Channel MOSFET IRF540NS (KRF540NS)

■ Typical Characteristics

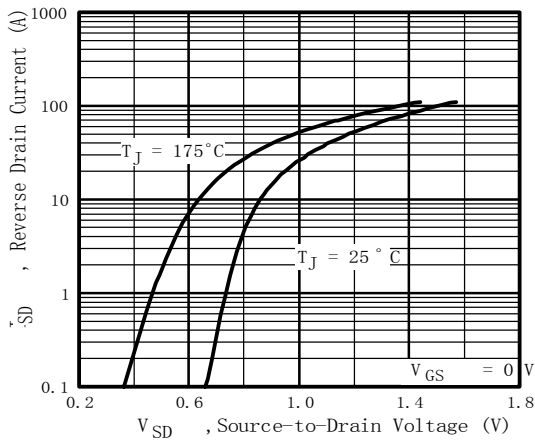


Fig 7. Typical Source-Drain Diode Forward Voltage

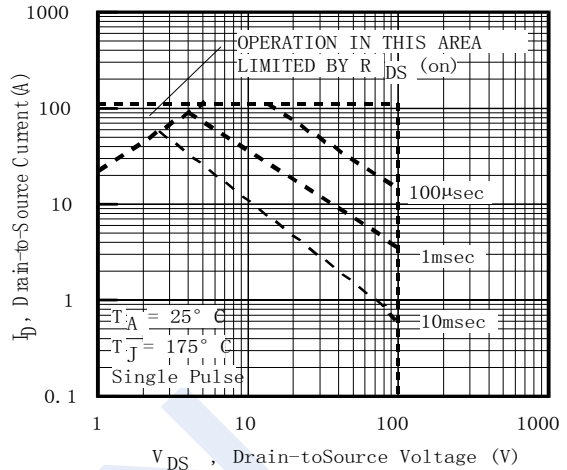


Fig 8. Maximum Safe Operating Area

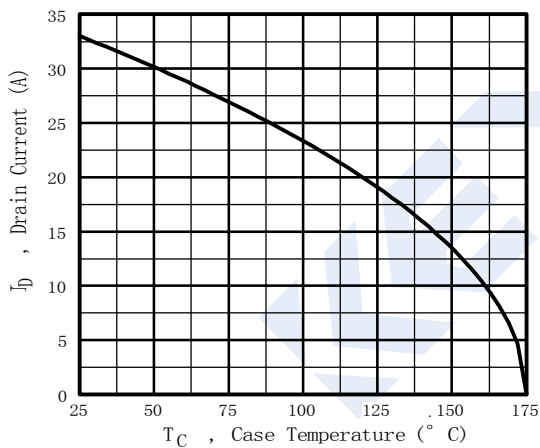


Fig 9. Maximum Drain Current Vs. Case Temperature

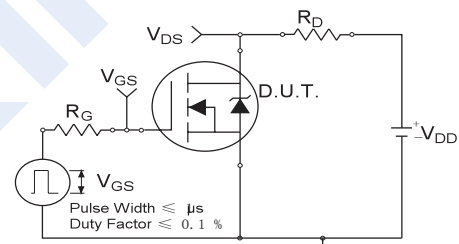


Fig 10a. Switching Time Test Circuit

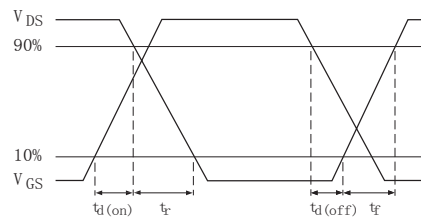


Fig 10b. Switching Time Waveforms

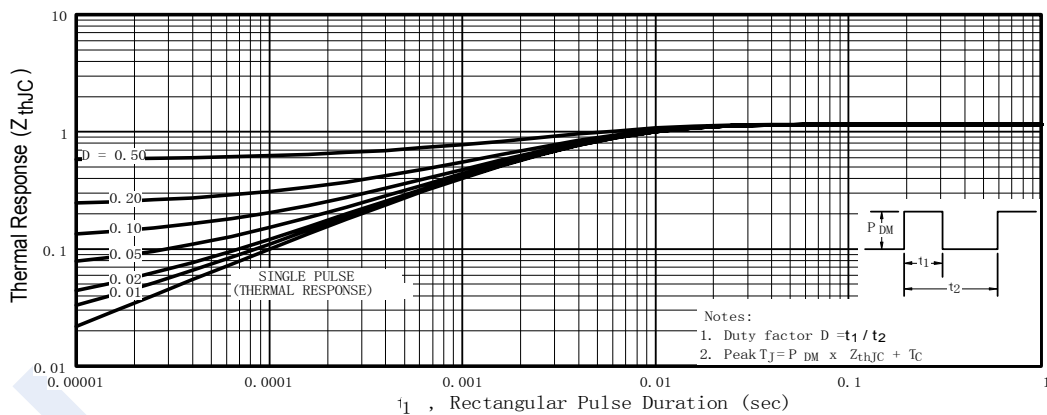
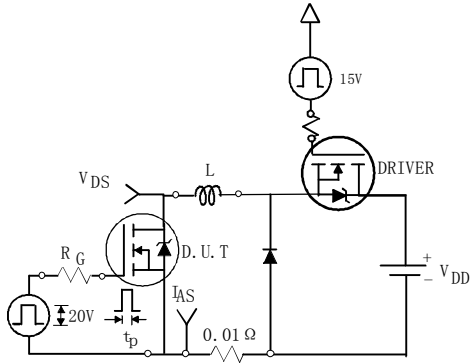


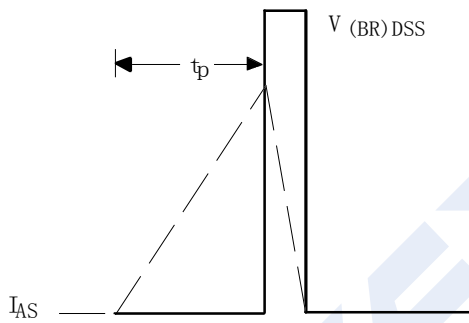
Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

## N-Channel MOSFET IRF540NS (KRF540NS)

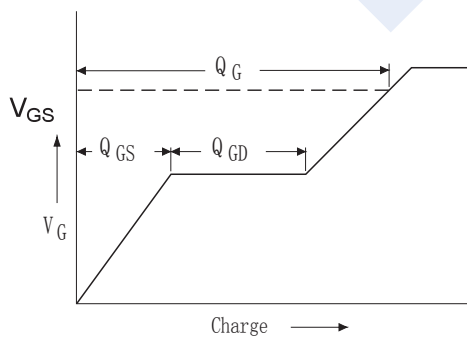
■ Typical Characteristics



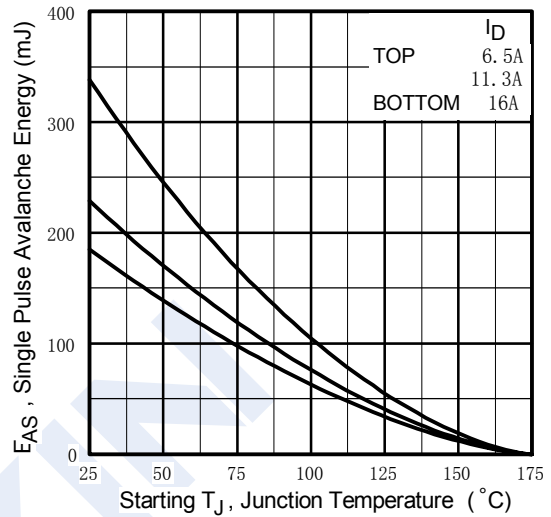
**Fig 12a.** Unclamped Inductive Test Circuit



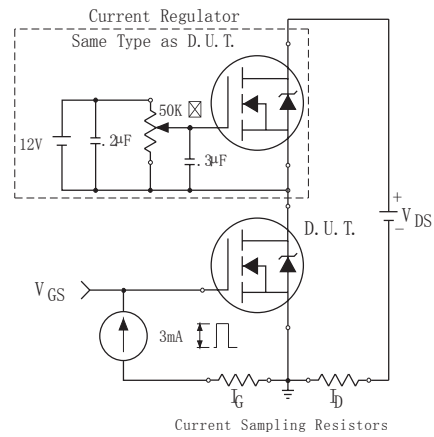
**Fig 12b.** Unclamped Inductive Waveforms



**Fig 13a.** Basic Gate Charge Waveform



**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

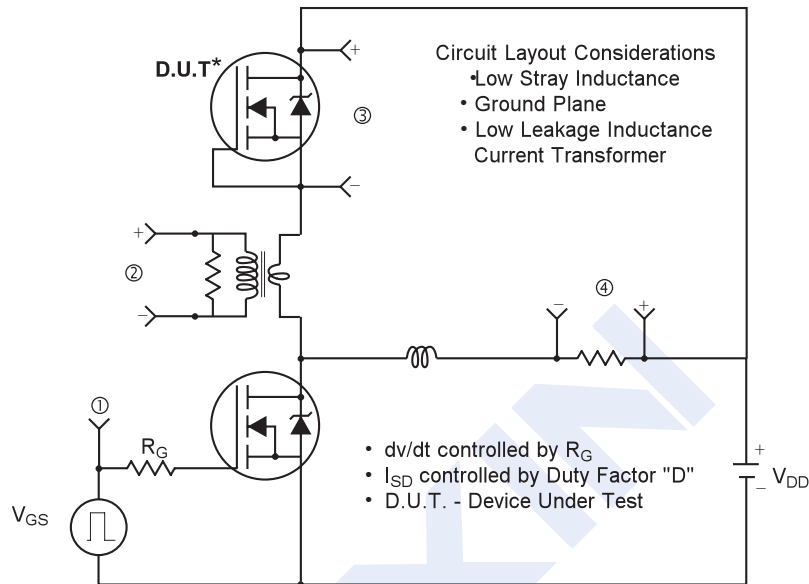


**Fig 13b.** Gate Charge Test Circuit

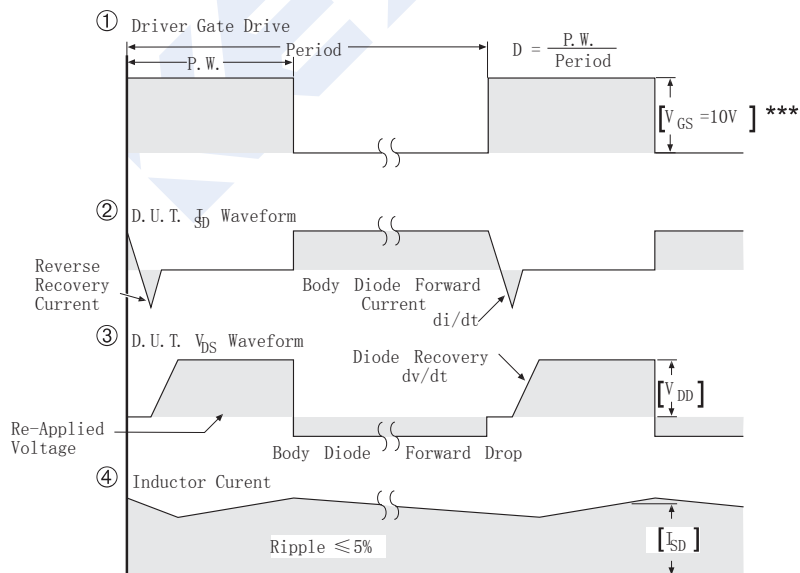
## N-Channel MOSFET IRF540NS (KRF540NS)

■ Typical Characteristics

### Peak Diode Recovery dv/dt Test Circuit



\* Reverse Polarity of D.U.T for P-Channel



\*\*\*  $V_{GS} = 5.0V$  for Logic Level and  $3V$  Drive Devices

Fig 14. For N-channel HEXFET® power MOSFETs